505860243 01/13/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MIN HOE KIM	11/22/2019
JOO HANG LEE	11/22/2019
HYE JIN JO	11/22/2019
SEONG BO KIM	11/22/2019
YANG HEE KIM	11/22/2019
JUNG EUN KIM	11/22/2019
SEUNG WON PARK	11/22/2019
EUN JUNG CHOI	11/22/2019

RECEIVING PARTY DATA

Name:	CJ CHEILJEDANG CORPORATION	
Street Address:	CJ CHEILJEDANG CENTER, 330	
Internal Address:	DONGHO-RO, JUNG-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	04560	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16624973	

CORRESPONDENCE DATA

Fax Number: (612)332-9081

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6123325300

Email: kwebber@merchantgould.com

Correspondent Name: RYAN C. SMITH **Address Line 1:** P.O. BOX 2903

Address Line 4: MINNEAPOLIS, MINNESOTA 55402-0903

ATTORNEY DOCKET NUMBER: 09983.0205FPWO
NAME OF SUBMITTER: RYAN C. SMITH

PATENT 505860243 REEL: 051571 FRAME: 0363

SIGNATURE:	/Ryan C. Smith/	
DATE SIGNED:	01/13/2020	
Total Attachments: 3		
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PATENT REEL: 051571 FRAME: 0364

eo-Gu			
1. KIM, Min Hoe residing at 262-1201, 131. Cheongna lime-ro Seo-Gu Incheon 22734. Republic of Korea and a citizen of Republic of Korea;			
2. LEE, Joo Hang residing at 102-2105, 10, Geongeon 8-gil, Sangnok-gu			
Ansan-Si Gyeonggi-do 15521, Republic of Korea and a citizen of Republic of Korea;			
3. JO, Hve Jin residing at 401-307, 194, Changnyong-daero, Paldal-gu Suwon-Si Gveonggi-do 16231, Republic of Korea and a citizen of Republic of Korea.			
c of Korea;			
4. KIM. Seong Bo residing at 810-602, 138. Yanghyeon-ro, Bundang-gu. Seongnam-Si, Gyeonggi-do 13567, Republic of Korea and a citizen of Republic			
on-gil,			
on-gu. und a citizen			
<u>tong-gu</u> Republic of			
ieung-gu.			
Republic of			
ındang-gu			
of <u>Republic</u>			
and have			
(herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States entitled and which:			
is the national stage application of International Application No.			
PCT/KR2018/007100 filed on June 22, 2018; claims priority to filed on:			
MENT.			
THE UNDERSIGNED hereby authorizes, and requests,			
ASSIGNEE'S legal representatives, of Merchant & Gould PC, who are associated with customer number 23552, to insert here in parenthesis (U.S. Serial No, filed			
iled			
Number and			
filing date, when known; was filed onand was given U.S. Serial No; or filed concurrently herewith;			
900			
1			

select the fourth check box if the application will be filed with the application. AND CI CHEILIEDANG CORPORATION (herein called "ASSIGNEE"), a Name of Corporation corporation organized under the laws of the Republic of Korea, and having an office and place of business at CI Cheiljedang Center 330, Dongho-ro, Jung-gu. Seoul 04560, Republic of Korea State or Country of wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor; Incorporation and Address NOW. THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for all countries in and to the invention disclosed in the aforesaid application and all the right(s) to claim priority thereto, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in all countries for Letters Patent on the said invention including as assignment of all rights under the provisions of the International Convention, and all Letters Patent of all countries which may be granted therefrom; and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns. THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be. THE UNDERSIGNED represent and agree with said ASSIGNEE its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED. IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below. Each inventor must sign & date Note: No legalization or other witness required Signature: Name: KINI, Min Hoe Signature: Name: LEE, Joo Hang

Page 2 of 3

Name: JO, Hye Jin	Signature:	Date: 1\/22/2019
Name: KIM, Seong Bo	Signature:	Date: 11/22/2019
Name: KIM, Yang Hee	Signature:	Date: / 11/22/2019
Name: KIM, Jung Eun	Signature:	Date: 11/22/2019
Name: PARK, Seung Won	Signature: Impah	Date:
Name: CHOI, Eun Jung	Signature: き」とだ	Date:

PATENT REEL: 051571 FRAME: 0367